

U.S. PATENT DOCUMENTS[illegible][illegible]

Dr. Herbert J. Neuhaus et al.	"Manufacturing and Reliability of Chip Module to Antenna Coil Contacts in Dual Interface Smart Cards"	Int'l Microelectronics and Packaging Society Symposium, October 1999
Dr. Herbert J. Neuhaus	"Advances in Materials for Low Cost Flip-Chip"	Advancing Microelectronics, Vol. 27, No. 4 July/August 2000, pp.12-14
Dr. Michael E. Wernle	"Manufacturing of Low Cost Smart Labels"	Int'l Microelectronics Symposium, September 2000
EXAMINER <i>[Signature]</i>		DATE CONSIDERED <i>[Signature]</i>

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